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# CM3103

# 400mA SmartOR<sup>TM</sup> Regulator with V<sub>AUX</sub> Switch

### **Features**

- Continuous 3.3V / 400mA output from two inputs
- Complete Power Management solution \_\_\_\_\_
- Built-in hysteresis when selecting input supplies
- Integrated switch featuring low RDS<sub>ON</sub> (0.25Ω typ.)
- Foldback current limiting protection
- Thermal overload shutdown protection
- 8-pin SOIC package
- Lead-free version available

# **Applications**

- PCI adapter cards with Wake-On-LAN
- Network Interface Cards (NICs)
- Multiple power supply systems
- Systems with standby capabilities

# Product Description

The CM3103 combines a fixed voltage regulator and a  $V_{AUX}$  switch in a single 8-pin SOIC package. The voltage regulator is capable of delivering up to 400mA continuously at 3.3V. The output power is provided from two independent input voltage sources on a prioritized basis. Power is always taken in priority of  $V_{CC}$ , then  $V_{AUX}$ .

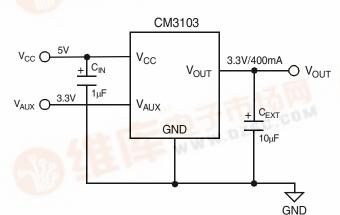
When  $V_{CC}$  (5V) is present, the device automatically enables the regulator, producing a stable 3.3V output at  $V_{OUT}$ , while disabling the  $V_{AUX}$  switch.

When only  $V_{AUX}$  (3.3V) is present, the device provides a low impedance direct connection (0.25 $\Omega$  typ.) from  $V_{AUX}$  to  $V_{OUT}$ .

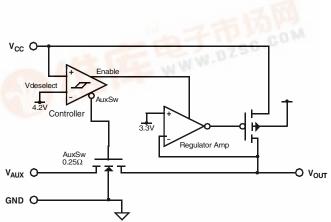
All the necessary control circuitry needed to provide a smooth and automatic transition between both supplies has been incorporated. This allows the  $V_{CC}$  input supply to be dynamically switched without loss of output voltage.

The CM3103 is available with optional lead-free finishing.

### Typical Application Circuit



### **Simplified Electrical Schematic**



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| PACKAGE / PINOUT DIAGRAM   |  |  |  |  |
|--|--|--|--|--|
| TOP VIEWN.C.18GND $V_{CC}$ 27GND $V_{OUT}$ 36GND $V_{AUX}$ 45GND |  |  |  |  |
| 8-pin Power SOIC   |  |  |  |  |
| Note: This drawing is not to scale.                              |  |  |  |  |

| PIN DESCRIPTIONS |                  |  |  |  |  |
|------------------|------------------|--|--|--|--|
| PIN(S)           | NAME             | DESCRIPTION  |  |  |  |
| 1                | N.C.             |  |  |  |  |
| 2                | v <sub>cc</sub>  | Positive input supply for the voltage regulator. Whenever this supply voltage exceeds the $V_{CCSEL}$ level (4.4V), it will immediately be given priority and be used to power the regulator output. If this supply voltage falls below the $V_{CCDES}$ level (4.2V) it will immediately be deselected and no longer provide power for the regulator output. An internal hysteresis voltage of 0.2V is used to prevent any chatter during selection and deselection of $V_{CC}$ . The effective source impedance of $V_{CC}$ should be kept below 0.3 ohm to ensure changeover disturbances do not exceed the hysteresis level. If the connection to $V_{CC}$ is made within a few inches of the main input filter, a bypass capacitor may not be necessary. Otherwise a bypass filter capacitor in the range of 1µF to 10µF will ensure adequate filtering. |  |  |  |
| 3                | V <sub>OUT</sub> | Regulator output. Power is provided from the regulator or via the low impedance auxiliary switch. This output requires a capacitance of $10\mu$ F to ensure regulator stability and minimize the peak output disturbance during power supply changeover.   |  |  |  |
| 4                | V <sub>AUX</sub> | Auxiliary voltage power source. This supply is selected only when V <sub>CC</sub> falls below 4.2V. Under these conditions an internal switch that provides a very low impedance connection directly between V <sub>OUT</sub> and V <sub>AUX</sub> is enabled .  |  |  |  |
| 5-8              | GND              | The negative reference for all voltages. Also functions as a thermal path for heat dissipation.  |  |  |  |

# **Ordering Information**

| PART NUMBERING INFORMATION |            |                     |              |                     |              |
|----------------------------|------------|---------------------|--------------|---------------------|--------------|
|                            |            | Standard Flnish     |              | Lead-fre            | e Finish     |
|                            |            | Ordering Part       |              | Ordering Part       |              |
| Pins                       | Package    | Number <sup>1</sup> | Part Marking | Number <sup>1</sup> | Part Marking |
| 8                          | Power SOIC | CM3103-01SA         | CM3103SA     | CM3103-01SF         | CM3103SF     |

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

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# **Specifications**

| ABSOLUTE MAXIMUM RATINGS                                  |  |          |  |  |
|---|--|----------|--|--|
| PARAMETER   | RATING                                     | UNITS    |  |  |
| ESD Protection (HBM)                                      | <u>+</u> 2000                              | V        |  |  |
| Pin Input Voltages<br>V <sub>CC</sub><br>V <sub>AUX</sub> | [GND - 0.5] to +6.0<br>[GND - 0.5] to +4.0 | V<br>V   |  |  |
| Storage Temperature Range                                 | -40 to +150                                | °C       |  |  |
| Operating Temperature Range<br>Ambient<br>Junction        | 0 to +70<br>0 to +125                      | °C<br>°C |  |  |
| Power Dissipation (See Note 1)                            | Internally Limited                         | W        |  |  |

Note 1: At rated load, the power dissipation will be 0.68Watt (1.7V x 0.4A). Under these conditions, (in a 70°C ambient), the thermal resistance from junction to ambient ( $\theta_{JA}$ ) must not exceed 80°C/W. This is typically achieved with 2 square inches of copper printed circuit board area connected to the GND pins for heat spreading, or equivalent.

| STANDARD OPERATING CONDITIONS       |                  |       |  |  |
|-------------------------------------|------------------|-------|--|--|
| PARAMETER                           | VALUE            | UNITS |  |  |
| V <sub>CC</sub>                     | 5.0 ±0.25        | V     |  |  |
| V <sub>AUX</sub>                    | 3.3 <u>+</u> 0.3 | V     |  |  |
| Ambient Operating Temperature Range | 0 to +70         | °C    |  |  |
| Load Current                        | 0 to 400         | mA    |  |  |
| C <sub>EXT</sub>                    | 10 <u>+</u> 20%  | μF    |  |  |

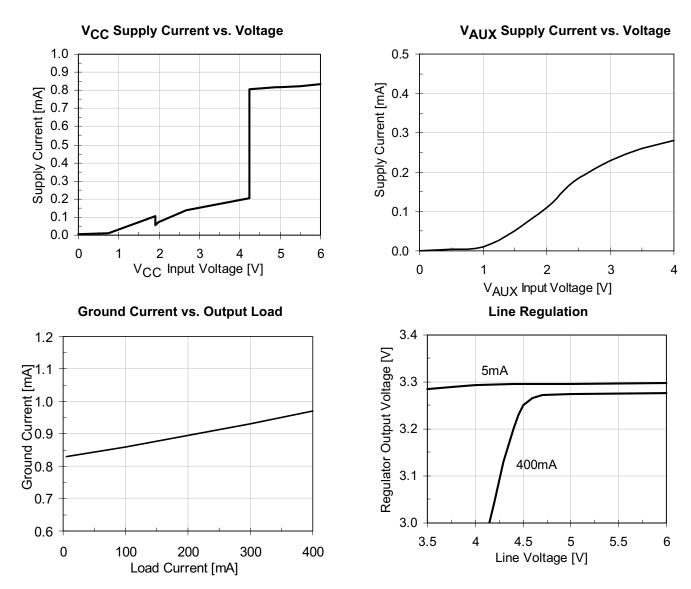
| ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1) |   |   |       |                      |                      |                |
|---|---|---|-------|----------------------|----------------------|----------------|
| SYMBOL  | PARAMETER   | CONDITIONS  | MIN   | TYP                  | MAX                  | UNITS          |
| V <sub>OUT</sub>                                  | Regulator Output Voltage  | 0mA < I <sub>LOAD</sub> < 400mA   | 3.135 | 3.300                | 3.465                | V              |
| I <sub>LIM</sub>                                  | Regulator Current Limit   | V <sub>OUT</sub> > 0V   | 410   | 500                  |                      | mA             |
| I <sub>S/C</sub>                                  | Short Circuit Current   | $V_{CC}$ =5V, $V_{OUT}$ < 0V  |       | 150                  |                      | mA             |
| V <sub>R LOAD</sub>                               | Load Regulation   | $V_{CC}$ =5V, 5mA $\leq I_{LOAD} \leq$ 400mA  |       | 20                   |                      | mV             |
| V <sub>R LINE</sub>                               | Line Regulation   | $I_{LOAD} = 5mA; 4.5V \le V_{IN} \le to 5.5V$   |       | 2                    |                      | mV             |
| V <sub>CCSEL</sub>                                | V <sub>CC</sub> Select Voltage                                      | V <sub>AUX</sub> present  |       | 4.40                 | 4.60                 | V              |
| V <sub>CCDES</sub>                                | V <sub>CC</sub> Deselect Voltage                                    | V <sub>AUX</sub> present  | 4.00  | 4.20                 |                      | V              |
| V <sub>HYST</sub>                                 | Hysteresis Voltage  | V <sub>AUX</sub> present; See Note 2  |       | 0.20                 |                      | V              |
| R <sub>SW</sub>                                   | V <sub>AUX</sub> Switch Resistance                                  |   |       | 0.25                 | 0.40                 | Ω              |
| I <sub>RCC</sub><br>I <sub>RAUX</sub>             | V <sub>CC</sub> Reverse Leakage<br>V <sub>AUX</sub> Reverse Leakage | One supply input taken to GND while the others remain at nominal voltage.   |       | 5                    | 100                  | μA             |
| I <sub>CC</sub>                                   | V <sub>CC</sub> Supply Current                                      | $V_{CC} > V_{CCSEL}, I_{LOAD}=0mA$  |       | 0.8                  | 1.5                  | mA             |
| I <sub>AUX</sub>                                  | V <sub>AUX</sub> Supply Current                                     | V <sub>AUX</sub> is selected, I <sub>LOAD</sub> =0mA  |       | 0.20                 | 0.30                 | mA             |
| I <sub>GND</sub>                                  | Ground Current  | $V_{AUX} \text{ is selected, } (V_{CC/SBY} = 0V)$<br>$V_{CC/SBY} = 5V, I_{LOAD} = 0mA$<br>$V_{CC/SBY} = 5V, I_{LOAD} = 400mA$ |       | 0.20<br>0.80<br>1.00 | 0.30<br>1.50<br>2.00 | mA<br>mA<br>mA |
| T <sub>DISABLE</sub><br>T <sub>HYST</sub>         | Shutdown Temperature<br>Thermal Hysteresis                          |   |       | 160<br>20            |                      | ℃<br>℃         |

Note 1: Operating characteristics are over Standard Operating Conditions unless otherwise specified.

Note 2: The disturbance on  $V_{CC}$  during supply changeover should be kept below the hysteresis voltage to prevent any chatter. The source resistance on the  $V_{CC}$  supply should be kept to less than 0.3 ohms to ensure precise switching.

## **Performance Information**

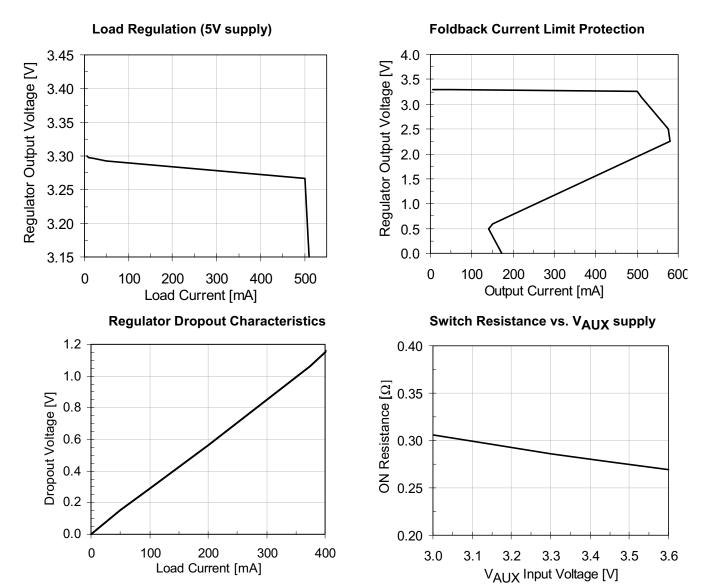
CM3103 Typical DC Characteristics (nominal conditions unless specified otherwise)



CM3103

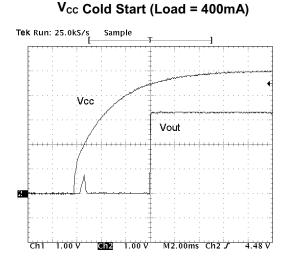
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CM3103 Typical DC Characteristics (cont'd, nominal conditions unless specified otherwise)

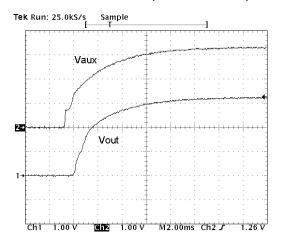


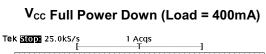


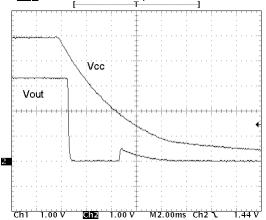
CM3103 Transient Characteristics (nominal conditions unless specified otherwise) (V\_{CC} source resistance set to 0.2 $\Omega$ )



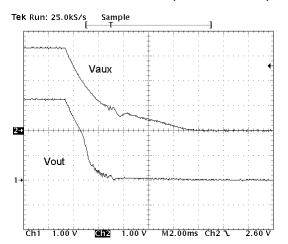
V<sub>AUX</sub> Cold Start (Load = 400mA)







V<sub>AUX</sub> Full Power Down (Load = 400mA)

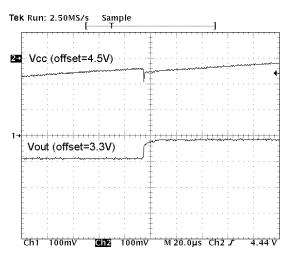


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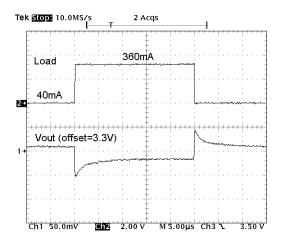
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CM3103 Transient Characteristics (cont'd; nominal conditions unless specified otherwise) ( $V_{CC}$  source resistance set to 0.2 $\Omega$ )

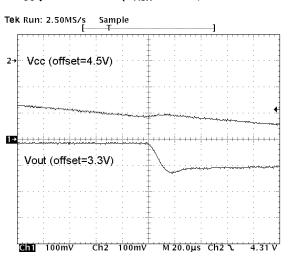
 $V_{CC}$  power up ( $V_{AUX}$  = 3.3V, Load = 300mA)



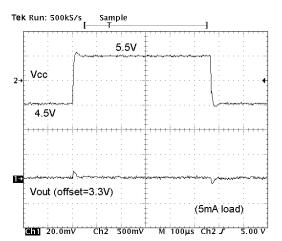
#### Load Transient Response (10% - 90% rated)



#### $V_{cc}$ power down ( $V_{AUX}$ = 3.3V, Load = 300mA)



#### Line Transient (1Vpp) Response



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#### **CM3103 Typical Thermal Characteristics**

The overall junction to ambient thermal resistance  $(\theta_{JA})$  for device power dissipation  $(P_D)$  consists primarily of two paths in series. The first path is the junction to the case  $(\theta_{JC})$  which is defined by the package style, and the second path is case to ambient  $(\theta_{CA})$  thermal resistance which is dependent on board layout. The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$T_{JUNC} = T_{AMB} + P_D (\theta_{JC}) + P_D (\theta_{CA})$$
$$= T_{AMB} + P_D (\theta_{JA})$$

The CM3103 uses a thermally enhanced package where all the GND pins (5 through 8) are integral to the leadframe. When this package is mounted on a double-sided printed circuit board with two square inches of copper allocated for "heat spreading", the resulting  $\theta_{JA}$  is about 50°C/W.

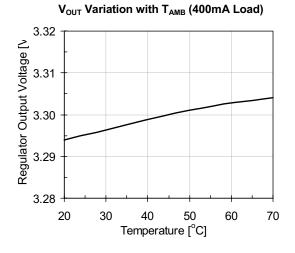
Based on a typical operating power dissipation of 0.7W (1.75V x 0.4A) with an ambient of 70°C, the resulting junction temperature will be:

$$T_{JUNC} = T_{AMB} + P_D (\theta_{JA})$$
  
= 70°C + 0.7W X (50°C/W)  
= 70°C + 35°C = 105°C

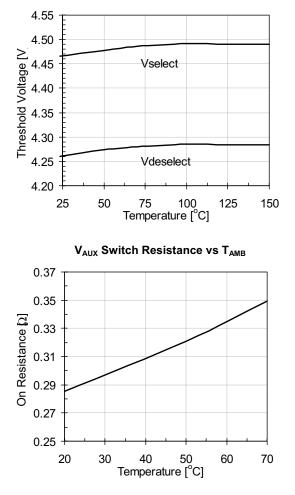
Thermal characteristics were measured using a doublesided board with two square inches of copper area connected to the GND pin for "heat spreading".

Measurements showing performance up to junction temperature of 125°C were performed under light load conditions (5mA). This allows the ambient temperature to be representative of the internal junction temperature.

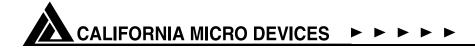
Note: The use of multi-layer board construction with separate ground and power planes will further enhance the overall thermal performance. In the event of no copper area being dedicated for heat spreading, a multi-layer board construction, using only the minimum size pad layout, will provide the CM3103 with an overall  $\theta_{JA}$  of 70°C/W which allows up to 780mW to be safely dissipated for the maximum junction temperature.



Select/Deselect Threshold Variation with TJUNCT



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### **Mechanical Details**

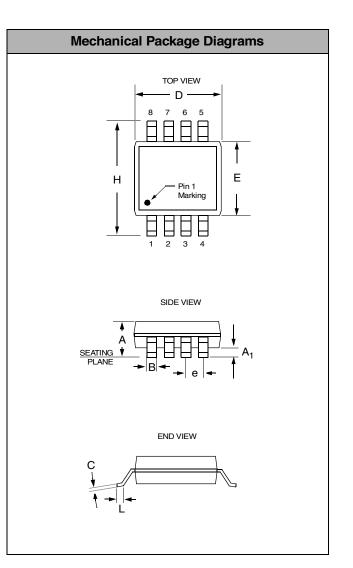
#### **SOIC-8 Mechanical Specifications**

Dimensions for CM3103 devices packaged in 8-pin SOIC packages are presented below.

For complete information on the SOIC-8 package, see the California Micro Devices SOIC Package Information document.

| PACKAGE DIMENSIONS            |             |      |           |       |  |
|-------------------------------|-------------|------|-----------|-------|--|
| Package                       | SOIC        |      |           |       |  |
| Pins                          | 8           |      |           |       |  |
| Dimensions                    | Millimeters |      | Inches    |       |  |
| Dimensions                    | Min         | Мах  | Min       | Мах   |  |
| Α                             | 1.35        | 1.75 | 0.053     | 0.069 |  |
| A <sub>1</sub>                | 0.10        | 0.25 | 0.004     | 0.010 |  |
| В                             | 0.33        | 0.51 | 0.013     | 0.020 |  |
| С                             | 0.19        | 0.25 | 0.007     | 0.010 |  |
| D                             | 4.80        | 5.00 | 0.189     | 0.197 |  |
| E                             | 3.80        | 4.19 | 0.150     | 0.165 |  |
| е                             | 1.27 BSC    |      | 0.050 BSC |       |  |
| Н                             | 5.80        | 6.20 | 0.228     | 0.244 |  |
| L                             | 0.40        | 1.27 | 0.016     | 0.050 |  |
| # per tube                    | 100 pieces* |      |           |       |  |
| # per tape<br>and reel        | 2500 pieces |      |           |       |  |
| Controlling dimension: inches |             |      |           |       |  |

\* This is an approximate number which may vary.



Package Dimensions for SOIC-8

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